PATENT ASSIGNMENT

SUBMISSION TYPE: NEW ASSIGNMENT

APPLICATION NUMBER 10/248225

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NATURE OF CONVEYANCE: ASSIGNMENT OF ASSIGNOR'S INTEREST

CONVEYING PARTY DATA

Name: Tong, Ho-Ming Execution Date: 10/24/2002

Name: Lee, Chun-Chi
Execution Date: 10/28/2002

Name: Fang, Jen-Kuang

Execution Date: <u>10/24/2002</u>

Name: <u>Huang, Min-Lung</u>

Execution Date: <u>10/28/2002</u>

Name: Chen, Jau-Shoung

Execution Date: <u>11/05/2002</u>

Name: Su, Ching-Huei

Execution Date: <u>11/01/2002</u>

Name: Weng, Chao-Fu

Execution Date: 10/29/2002

Name: <u>Lee, Yung-Chi</u> **Execution Date:** 11/05/2002

Name: Chou, Yu-Chen

Execution Date: <u>11/05/2002</u>

Name: <u>Wu, Tsung-Hua</u>

Execution Date: <u>10/24/2002</u>

Name: <u>Tao, Su</u> Execution Date: 10/28/2002

RECEIVING PARTY DATA

Name: Advanced Semiconductor Engineering, Inc.

Street Address: 26, Chin 3rd Rd., 811, Nantze Export Processing Zone

Internal Address:

City: Kaohsiung

PATENT

800004664 REEL: 013317 FRAME: 0424

State:

Country: <u>TAIWAN</u>

Postal Code:

The USPTO, Office of Public Records, will send correspondence

via facsimile to FAX NUMBER: 886-2-2369-7233

CORRESPONDENCE DATA:

Correspondence will be sent via US Mail when a fax number

has not been provided or the fax attempt is unsuccessful.

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 031561

NAME OF PERSON SIGNING: Belinda Lee DATE SIGNED: 12/23/2002

Total Attachments: 3

PATENT REEL: 013317 FRAME: 0425

ASSIGNMENT

WHEREAS,

- 1. Ho-Ming Tong
- 3. Jen-Kuang Fang
- 5. Jau-Shou Chen
- 7. Chao-Fu Weng
- 9. Yu-Chen Chou
- 11. Tao. Su

- 2. Chun-Chi Lee
- 4. Min-Lung Huang
- 6. Ching-Huei Su
- 8. Yung-Chi Lee
- 10. Tsung-Hua Wu

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: SOLDER BALL ATTACHING PROCESS

[] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Advanced Semiconductor Engineering, Inc.

of 26, Chin 3rd. Rd., 811, Nantze Export Processing Zone, Kaohsiung, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have si indicated.	gned his/her/their name(s) on the date(s)
Signature: Joy	/0/24/02 - Date:
Signature:	Date:
Sole or First Joint Inventor: Ho-Ming Tong	
church le	10/20/6V
Signature:	Date:
Second Joint Inventor(if any): Chun-Chi Lee	
Jen-Knang Toping Signature:	1%4/ox
Signature.	Date:
Third Joint Inventor(if any): Jen-Kuang Fang	\$ 1.50 miles
Min-Lung Huang	(Φ / 2 / / 0 2 Date:
Signature:	Date:
Fourth Joint Inventor(if any): Min-Lung Huang	
Signature:	11/5/2002_ Date:
Signature: //	Date:
Fifth Joint Inventor(if any): Jau-Shoung Chen	
Ching- Huei Su Signatures	11 /61 /02 Date:
Signatures	Date:
Sixth Joint Inventor(if any): Ching-Huei Su	
Chao-Fu Weng	19/29/02
Signature:	Date:
Seventh Joint Inventor(if any): Chao-Fu Weng	
Yung - Chi Lee Signature:	Doto:
Signature:	Date:
Eighth Joint Inventor(if any): Yung-Chi Lee	

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s)

Signature:

Ninth Joint Inventor(if any): Yu-Chen Chou

James Date:

Tenth Joint Inventor(if any): Tsung-Hua Wu

Tao Su

Signature:

Date:

Toly 4 for

Date:

Date:

Eleventh Joint Inventor(if any): Tao, Su

RECORDED: 12/30/2002

PATENT REEL: 013317 FRAME: 0428